## **Bringing tomorrow's** electronics to life



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North America 554 Clark Rd., Tewksbury, MA USA 01876 Tel: +1 978 667 9449 Email: sales.mrsi@mycronic.com





mrsisystems.com



MRSI China 101, Block A, Huahan Innovation Park, Langshan Road, Shenzhen, China 518057 Tel: +86 755 26414155

## MRSI-175Ag **EPOXY DISPENSER**



MRSI Systems has been serving optoelectronic and microelectronic customers for over 35 years and understands their requirement to scale efficiently in today's fast-paced marketplace.

**Applications** exist across a wide range of market segments, such as life & health sciences, aerospace, defense, automotive, lighting, communications, and more.

MRSI's die bonding solutions help our customers to enable just-in-time supply and fast-pace innovations of critical components for high-growth market segments. The MRSI-175Ag Conductive Epoxy Dispenser handles the most demanding dispensing applications such as semiconductor packaging, microwave & RF modules, multi-chip modules, optical modules, hybrid circuits, sensors, and MEMS.

Our die bonding solutions are built on standardized hardware and software platforms configured to minimize process deviations, reduce NPI cost, deliver long term proven product reliability and supported by our global customer service team. These factors deliver the best financial returns in the industry.



#### MRSI-175Ag Epoxy Dispenser **Highly Configurable**

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#### Assembly Technologies

- Underfill
- Die attach
- Encapsulation
- Multi-pin stamping

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#### Flexible Dispensing Platform

- Increased Capacity at Lower Cost
- Lower Cost of Ownership
- Less Labor Cost
- Higher Yields
- Flexibility





- Semiconductor Packaging
- Microwave & RF Modules
- Multi-chip Modules
- Optical Modules
- Hybrid Circuits
- Sensors
- MEMS

